8 Line LCD & Camera EMI **Filter with ESD Protection**

NUF8152MU is an 8 line LRC EMI filter array designed for LCD and camera portable applications. It provides superior attenuation at frequencies from 800 MHz to 3.0 GHz and offers ESD protection-clamping transients from static discharges. Housed in a UDFN package, it is specifically designed for low profile or slim-design electronics where space and height are at a premium. ESD protection is provided across all capacitors.

Features

- Provides EMI Filtering and ESD Protection
- Integration of 40 Discretes
- Compliance with IEC61000-4-2 (Level 4) 13 kV (Contact)
- UDFN16, 1.2 x 3.5 mm Package
- Low Profile, 0.5 mm Height Typical
- 0.4 mm Pitch
- Moisture Sensitivity Level 1
- ESD Ratings: Machine Model = C Human Body Model = 3B
- Excellent Line Efficiency with Low Line Resistance
- This is a Pb-Free Device*

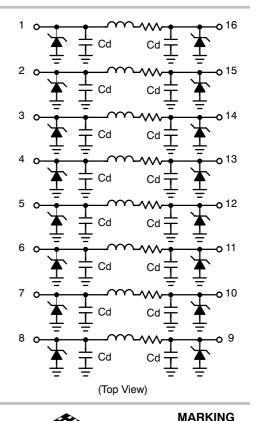
Applications

- Headset
- MP3s
- PDAs
- Digital Cameras
- Portable DVDs
- Hands-Free Interface



ON Semiconductor®

http://onsemi.com





CASE 517AF

UDFN16

= Assembly Location

= Specific Device Code

DIAGRAM 10

815

AYW

= Year = Work Week W = Pb-Free Package

815

1

ORDERING INFORMATION

	Device	Package	Shipping [†]
٨	IUF8152MUT2G	UDFN16 (Pb-Free)	3000 / Tape & Reel

[†]For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

^{*}For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

MAXIMUM RATINGS

Parameter	Symbol	Value	Unit
ESD Discharge IEC61000-4-2 Contact Discharge	V _{PP}	13	kV
Operating Temperature Range	T _{OP}	-40 to 85	°C
Storage Temperature Range	T _{stg}	-55 to 150	°C
Maximum Lead Temperature for Soldering Purposes (1.8 in from case for 10 s)	TL	260	°C

Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Parameter	Test Conditions	Symbol	Min	Тур	Max	Unit
Maximum Reverse Working Voltage		V _{RWM}			5.0	V
Breakdown Voltage	I _R = 1.0 mA	V _{BR}	6.0	7.0	8.0	V
Leakage Current	V _{RWM} = 3.3 V	I _R			0.1	μΑ
Inductance		L		1.0	3.0	nH
Resistance (Line)		R		28	36	Ω
Capacitance (Note 1, 2)		C _d		17		pF
Cut-Off Frequency (Note 3)	Above this frequency, appreciable attenuation occurs	f _{3dB}		125		MHz

^{1.} Measured at 25°C, V_R = 2.5 V, f = 1.0 MHz. 2. Total line capacitance is 2 times the diode capacitance (C_d). 3. 50 Ω source and 50 Ω load termination.

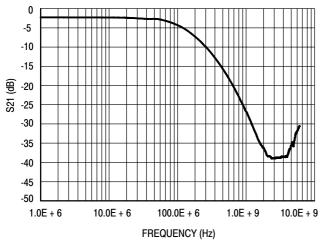


Figure 1. Typical Insertion Loss Characteristics (S21 Measurement)

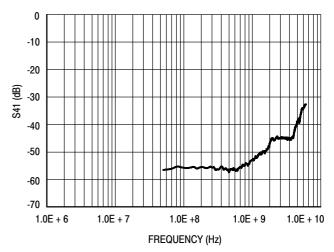


Figure 2. Analog Crosstalk Curve (S41 Measurement)

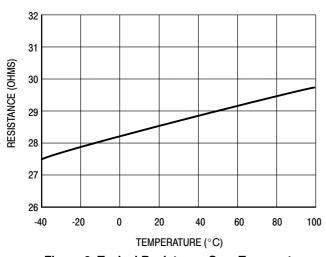


Figure 3. Typical Resistance Over Temperature

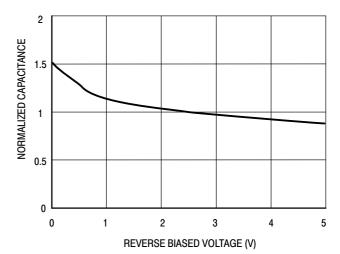
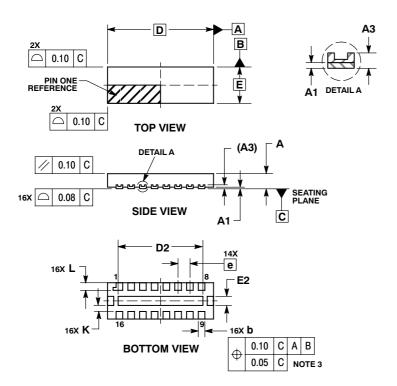


Figure 4. Typical Line Capacitance vs. Reverse Bias Voltage (Normalized to Capacitance @ 2.5 V)

PACKAGE DIMENSIONS

UDFN16, 3.5x1.2, 0.4P CASE 517AF-01 **ISSUE B**



NOTES:

- NOTES:

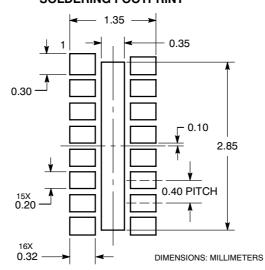
 1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.

 2. CONTROLLING DIMENSION: MILLIMETERS.

 3. DIMENSION 5 APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.25 AND
- 0.30 mm FROM TERMINAL. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

	MILLIMETERS					
DIM	MIN	NOM	MAX			
Α	0.45	0.50	0.55			
A1	0.00	0.03	0.05			
A3	0.127 REF					
b	0.15	0.20	0.25			
D	3.50 BSC					
D2	2.70	2.80	2.90			
E	1.20 BSC					
E2	0.20	0.30	0.40			
е	0.40 BSC					
K	0.20		-			
L	0.20	0.25	0.30			

SOLDERING FOOTPRINT*



*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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